ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES International and P	IPC, Bannockt	ourn, Illinois. A	ll rights reserved untions.	under both	This docum level parts,	ent is a decla	ration of point encomp	the substances passes all low	s within the manufactu er level materials for v	urer listed	item. Note: i nanufacture	f the item is an as r has engineering	ssembly with lower responsibility.	
				Form Type Distribute					rials and N	ials and Mfg Information				
Supplier Information														
Company name*	Company unique ID			Unique ID Authority				Respon	Response Date*					
onsemi										2025-07	2025-07-02			
Contact Name Title - Contact			act			Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards Pro			Product Enviro Compliance			NA				Produc	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - R			le - Representative			Phone - Representative*			Email -	Email - Representative*				
Product-Env-Stewards	Product Enviro Compliance				NA				Produe	Product-Env-Stewards@onsemi.com				
Requester Item Number	Requester Item Number Mfr Item		Number Mfr Item Name			Effective D	ate Ver	rsion	Manufacturing Site		Weight*	UOM	Unit Type	
	NCP137	NCP137AFCT105T2G 700 mA, Very Low CMOS Voltage Re		w Dropout Bias Regulator	s Rail	2025-07-02		CNQ			0.70206	mg	Each	
Manufacturing Proccess Inform	ation													
Terminal Plating / Grid Array M	Terminal Plating / Grid Array Material Terminal Base Alloy		Alloy	J-STD-020 MS	L Rating	Peak P	rocess Bo	ody Temperatu	ure Max Time at Peal	k Tempera	ture Numb	per of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	secon	nds 3				
Comments														
level 1 - maximum time at peak tempera	ture during so	dering is 10-3	0 seconds											
For more information regarding materia	al composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select select a RoHS exemption, if applic sigma range of distribution unless	cable [E] enter the weigh							
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.52992	mg	Supplier	Silicon (Si)	7440-21-3		0.5299	mg
Plating	0.10106	mg	Supplier	Tin (Sn)	7440-31-5		0.1011	mg
Protection coat	0.01363	mg		Polyimide	proprietary data		0.0136	mg
RDL	0.02674	mg	Supplier	Titanium (Ti)	7440-32-6		0.0002	mg
			Supplier	Copper (Cu)	7440-50-8		0.0265	mg
UBM Sputter	0.03071	mg	Supplier	Titanium (Ti)	7440-32-6		0.0002	mg
		-	Supplier	Copper (Cu)	7440-50-8		0.0306	mg